

## 650V GaN HEMT

### Description

The CC65H270TOAIF Series 650V, 270mΩ gallium nitride (GaN) FETs are normally-off devices.

Classicchip GaN FETs offer better efficiency through lower gate charge, faster switching speeds, and lower dynamic onresistance, delivering significant advantages over traditional silicon (Si) devices.

Classicchip is a leading-edge wide band gap supplier with world-class innovation .

### Automotive

- Adapter
- Renewable energy
- Telecom and data-com
- Servo motors
- Industrial
- Automotive

### General Features

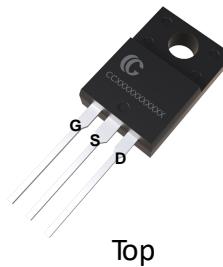
Easy to drive—compatible with standard gate drivers  
 Low conduction and switching losses  
 RoHS compliant and Halogen-free

### Benefits

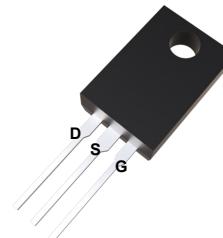
Increased efficiency through fast switching  
 Increased power density  
 Reduced system size and weight

### Ordering Information

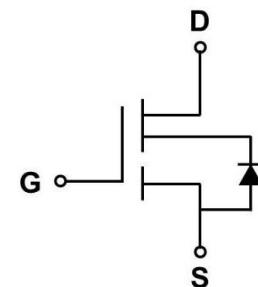
Part Number	Package	Package Configuration
CC65H270TOAIF	TO220F	Source



Top



Bottom



Circuit Symbol

### Features

$BV_{DSS}$	$R_{DS(on)}$	$I_{DS}$	$Q_G$
650V	270mΩ	7.9A	7.9nC

## Absolute Maximum Ratings

$T_C=25^\circ\text{C}$  unless otherwise stated

Symbol	Parameter	Limit value	Unit
$V_{DSS}$	Drain to source voltage ( $T_J = -55^\circ\text{C}$ to $150^\circ\text{C}$ )	650	
$V_{(\text{TR})DSS}$	Drain to source voltage-transient <sup>a</sup>	800	V
$V_{GSS}$	Gate to source voltage	-20~+20	
$I_D$	Continuous drain current @ $T_C=25^\circ\text{C}$ <sup>b</sup>	7.9	
	Continuous drain current @ $T_C=125^\circ\text{C}$ <sup>b</sup>	3.5	A
$I_{DM}$	Pulse drain current (pulse width: 100μs)	14	A
$P_D$	Maximum power dissipation @ $T_C=25^\circ\text{C}$	32	W
$T_C$	Operating temperature	Case	$-55\text{~}150$ $^\circ\text{C}$
$T_J$		Junction	$-55\text{~}150$ $^\circ\text{C}$
$T_S$	Storage temperature	-55~150	$^\circ\text{C}$

a. In off-state, spike duty cycle D<0.01, spike duration <1μs

b. For increased stability at high current operation

## Thermal Resistance

Symbol	Parameter	Limit value	Unit
$R_{\theta JC}$	Junction-to-case	3.9	°C /W

## Electrical Parameters

T<sub>J</sub>=25°C unless otherwise stated

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
<b>Forward Device Characteristics</b>						
V <sub>(BL)DSS</sub>	Drain-source voltage	650	-	-	V	V <sub>GS</sub> = 0V
V <sub>GS(th)</sub>	Gate threshold voltage	-	4	-	V	
ΔV <sub>GS(th)/T<sub>J</sub></sub>	Gate threshold voltage temperature coefficient	-	-7	-	mV/°C	V <sub>DS</sub> =1V, I <sub>DS</sub> =1mA
R <sub>DS(on)</sub>	Drain-source on-resistance	-	270	320	mΩ	V <sub>GS</sub> =10V, I <sub>D</sub> =1A, T <sub>J</sub> =25°C
		-	570	-		V <sub>GS</sub> =10V, I <sub>D</sub> =1A, T <sub>J</sub> =150°C
I <sub>DSS</sub>	Drain-to-source leakage current	-	-	10	μA	V <sub>DS</sub> =650V, V <sub>GS</sub> = 0V, T <sub>J</sub> =25°C
		-	-	100		V <sub>DS</sub> =650V, V <sub>GS</sub> = 0V, T <sub>J</sub> =150°C
I <sub>GSS</sub>	Gate-to-source forward leakage current	-	-	±100	nA	V <sub>GS</sub> =±20V
C <sub>ISS</sub>	Input capacitance	-	293	-		
C <sub>OSS</sub>	Output capacitance	-	17	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =400V, f=1MHz
C <sub>RSS</sub>	Reverse capacitance	-	3.74	-		
Q <sub>G</sub>	Total gate charge	-	7.9	-		
Q <sub>GS</sub>	Gate-source charge	-	2.31	-	nC	V <sub>DS</sub> =400V, V <sub>GS</sub> =0V to 10V, I <sub>D</sub> =1A
Q <sub>GD</sub>	Gate-drain charge	-	1.65	-		
Q <sub>OSS</sub>	Output charge	-	22.2	-	nC	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V to 400V, f=1MHz
t <sub>D(on)</sub>	Turn-on delay	-	3.2	-		
t <sub>R</sub>	Rise time	-	5.5	-		
t <sub>D(off)</sub>	Turn-off delay	-	7.4	-	ns	V <sub>DS</sub> =400V, V <sub>GS</sub> =0V to 10V, I <sub>D</sub> =2.1A, R <sub>G-on(ext)</sub> =6.8Ω, R <sub>G-off(ext)</sub> =2.2Ω, L=250μH
t <sub>F</sub>	Fall time	-	27	-		

## Electrical Parameters

T<sub>J</sub>=25°C unless otherwise stated

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
<b>Reverse Device Characteristics</b>						
V <sub>SD</sub>	Source-Drain reverse voltage	-	2.3	-	V	V <sub>GS</sub> =0V, I <sub>SD</sub> =5A
t <sub>RR</sub>	Reverse recovery time	-	14	-	ns	
Q <sub>RR</sub>	Reverse recovery charge	-	6.5	-	nC	I <sub>F</sub> =10A, V <sub>DD</sub> =400V, dI <sub>F</sub> /dt=165A/μs

## Typical Characteristics

$T_J=25^\circ\text{C}$  unless otherwise stated

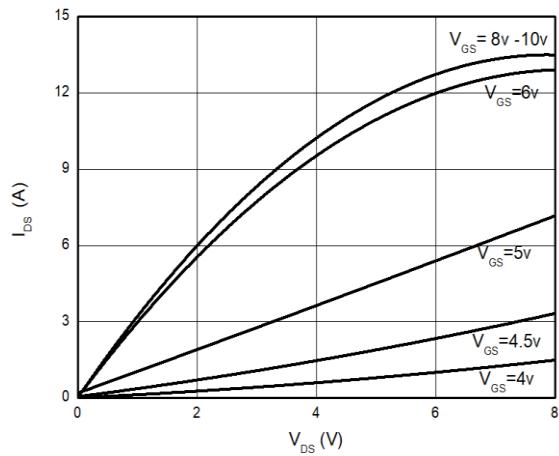


Figure 1. Typical Output Characteristics  $T_J=25^\circ\text{C}$

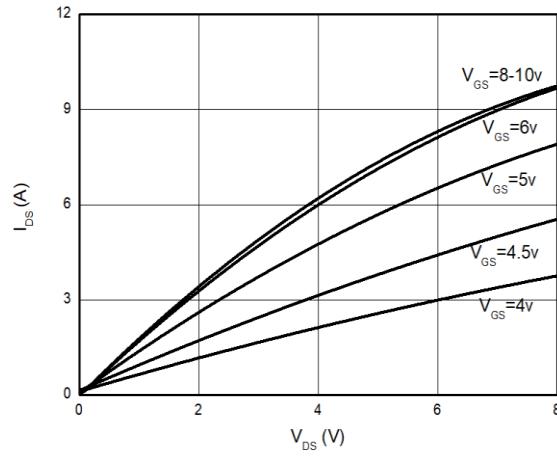


Figure 2. Typical Output Characteristics  $T_J=125^\circ\text{C}$

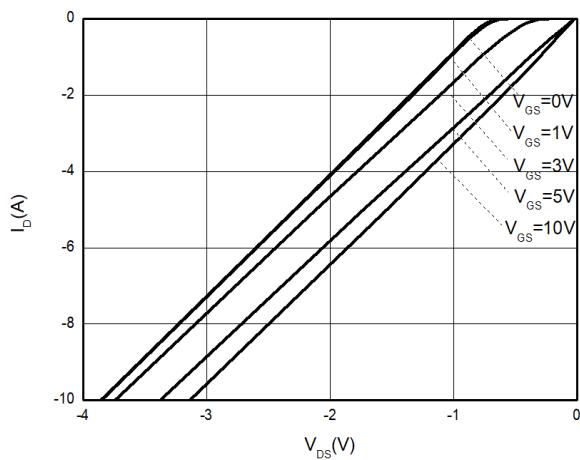


Figure 3. Channel Reverse Characteristics  $T_J=25^\circ\text{C}$

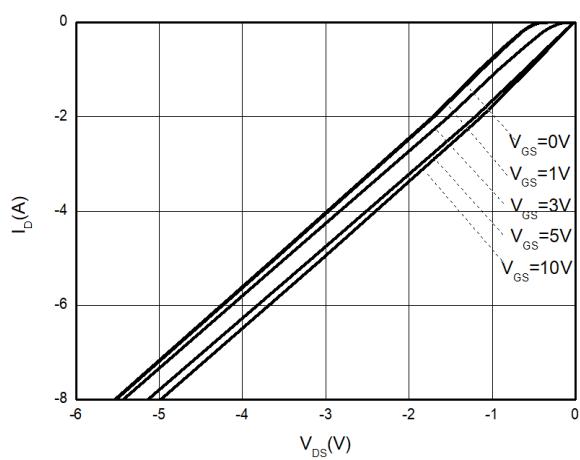


Figure 4. Channel Reverse Characteristics  $T_J=125^\circ\text{C}$

## Typical Characteristics

$T_J=25^\circ\text{C}$  unless otherwise stated

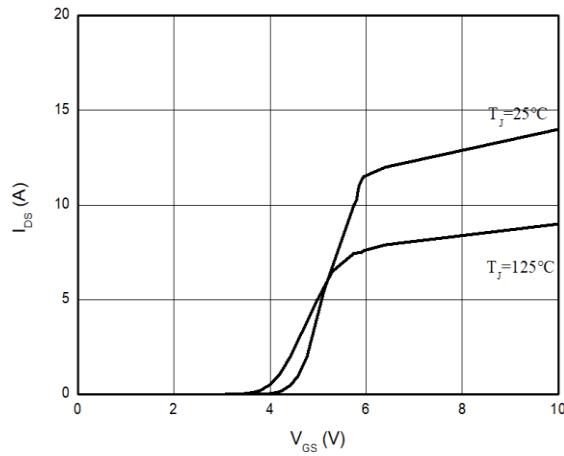


Figure 5. Typical Transfer Characteristics ( $V_{DS}=5\text{V}$ )

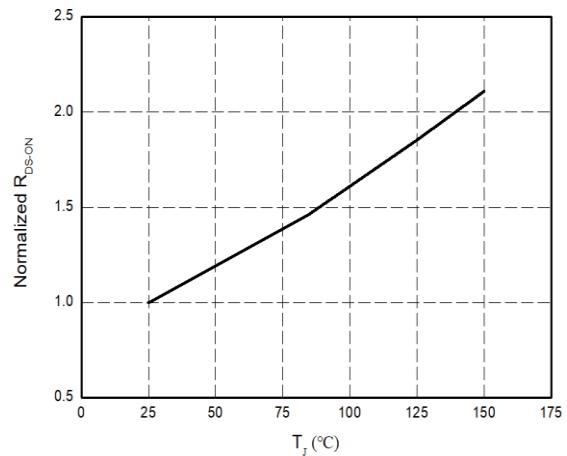


Figure 6. Normalized On-resistance

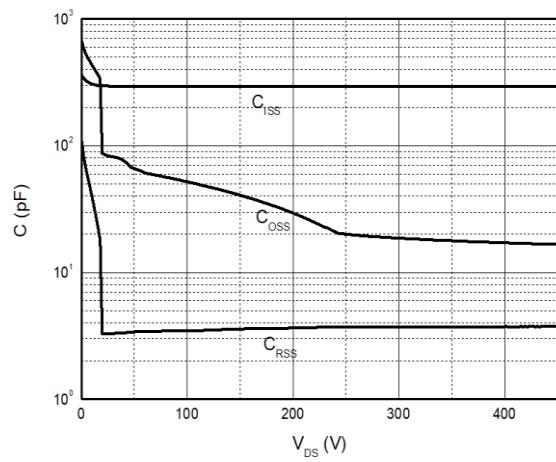


Figure 7. Typical Capacitance ( $f=1\text{MHz}$ )

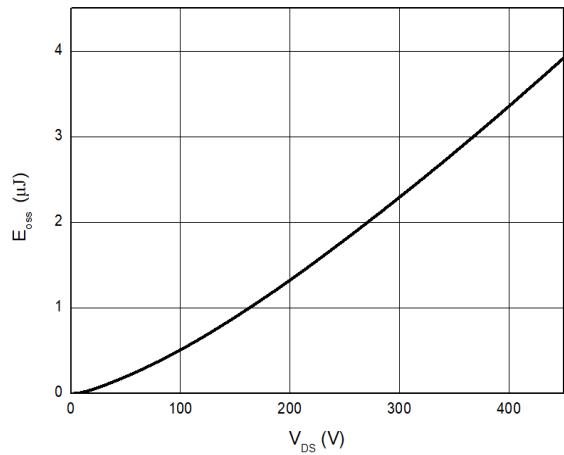


Figure 8. Typical C<sub>OSS</sub> Stored Energy

## Typical Characteristics

T<sub>J</sub>=25°C unless otherwise stated

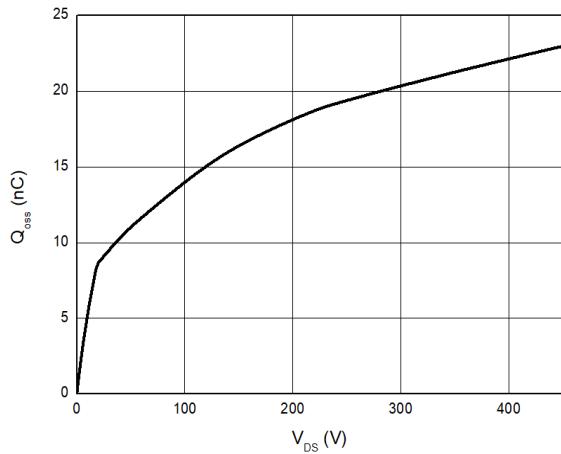


Figure 9. Typical Q<sub>oss</sub>

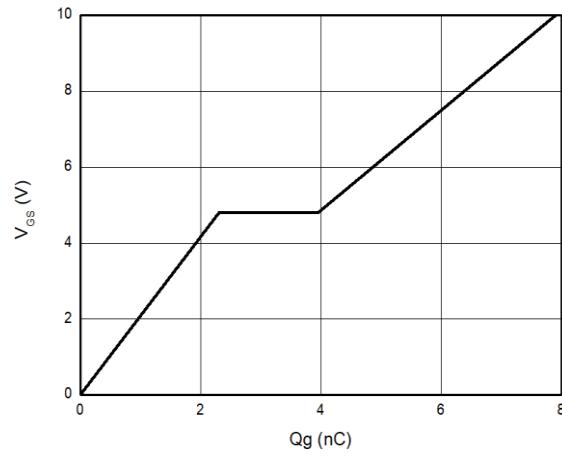


Figure 10. Typical Gate Charge (V<sub>DS</sub>=400V, I<sub>D</sub>=1A)

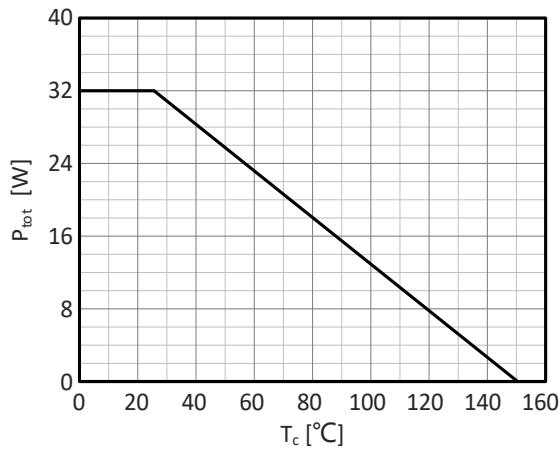


Figure 11. Power Dissipation

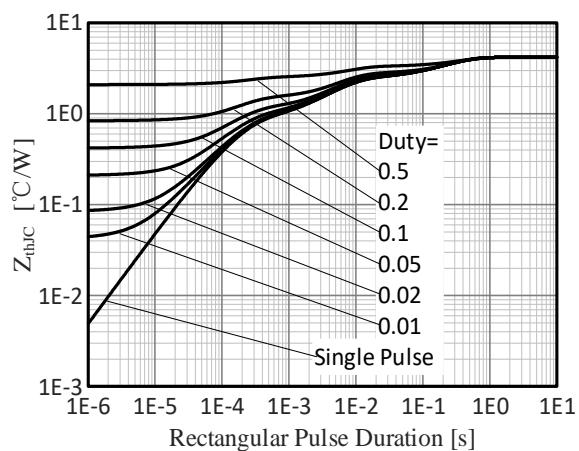


Figure 12. Transient Thermal Resistance

## Typical Characteristics

$T_J=25^\circ\text{C}$  unless otherwise stated

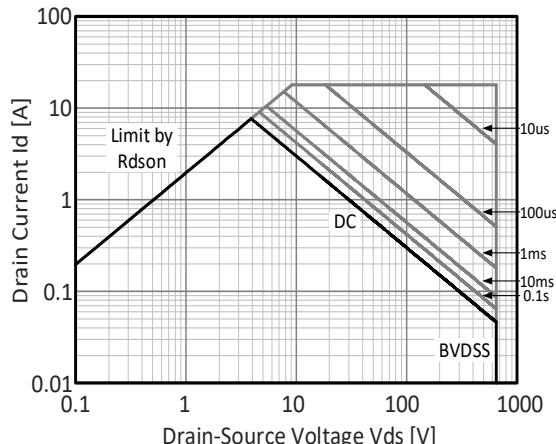


Figure 13. Safe Operating Area  $T_c=25^\circ\text{C}$

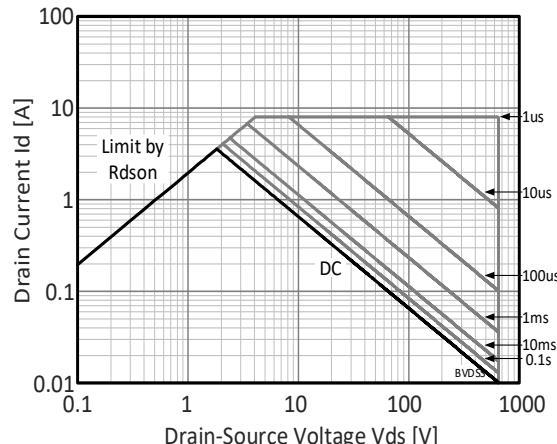


Figure 14. Safe Operating Area  $T_c=125^\circ\text{C}$

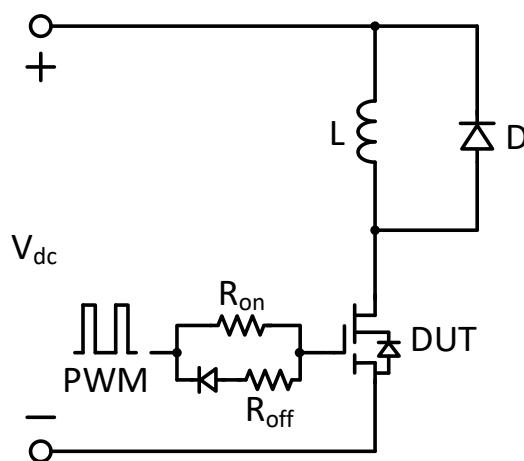


Figure 15. Switching times with inductive load

$$V_{DS}=400\text{V}, V_{GS}=0\text{V} \text{ to } 10\text{V}, I_D=2.1\text{A}, \\ R_{G-on(ext)}=6.8\Omega, R_{G-off(ext)}=2.2\Omega, L=250\mu\text{H}$$

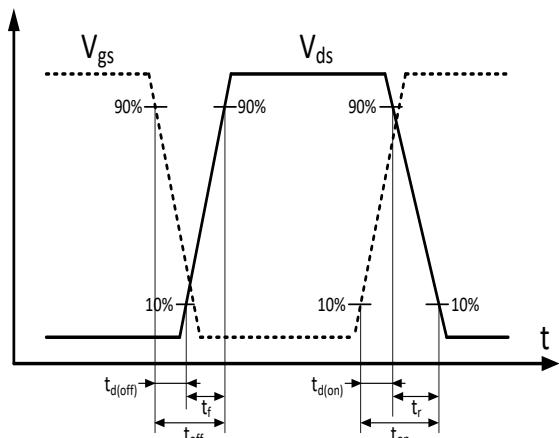
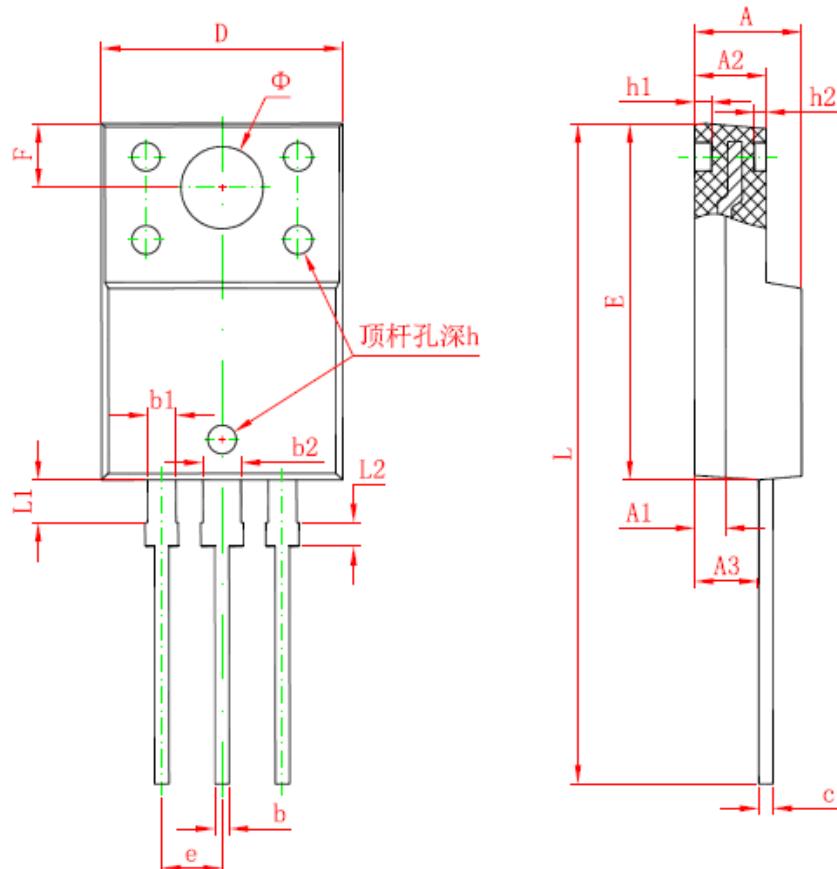


Figure 16. Switching times with waveform

## PACKAGE DIMENSIONS

TO220F-3L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.300	4.700	0.169	0.185
A1	1.300	REF.	0.051	REF.
A2	2.800	3.200	0.110	0.126
A3	2.500	2.900	0.098	0.114
b	0.500	0.750	0.020	0.030
b1	1.100	1.350	0.043	0.053
b2	1.500	1.750	0.059	0.069
c	0.500	0.750	0.020	0.030
D	9.960	10.360	0.392	0.408
E	14.800	15.200	0.583	0.598
e	2.540	TYP.	0.100	TYP.
F	2.700	REF.	0.106	REF.
Φ	3.500	REF.	0.138	REF.
h	0.000	0.300	0.000	0.012
h1	0.800	REF.	0.031	REF.
h2	0.500	REF.	0.020	REF.
L	28.000	28.400	1.102	1.118
L1	1.700	1.900	0.067	0.075
L2	0.900	1.100	0.035	0.043